# 74HC157-Q100; 74HCT157-Q100

# Quad 2-input multiplexer Rev. 1 — 2 August 2012

Product data sheet

#### **General description** 1.

The 74HC157-Q100; 74HCT157-Q100 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL. It is specified in compliance with JEDEC standard no. 7A.

The 74HC/HCT157-Q100 are quad 2-input multiplexers which select 4 bits of data from two sources under the control of a common data select input (S). The enable input (E) is active LOW. When E is HIGH, all of the outputs (1Y to 4Y) are forced LOW regardless of all other input conditions.

Moving the data from two groups of registers to four common output buses is a common use of the 74HC/HCT157-Q100. The state of the common data select input (S) determines the particular register from which the data comes. It can also be used as function generator. The device is useful for implementing highly irregular logic by generating any four of the 16 different functions of two variables with one variable common. The 74HC/HCT157-Q100 is logic implementation of a 4-pole, 2-position switch, where the position of the switch is determined by the logic levels applied to S.

The logic equations are:

$$\begin{aligned} 1 & Y = \overline{E} \times (111 \times S + 110 \times \overline{S}) \\ 2 & Y = \overline{E} \times (211 \times S + 210 \times \overline{S}) \\ 3 & Y = \overline{E} \times (311 \times S + 310 \times \overline{S}) \end{aligned}$$

 $4Y = \overline{E} \times (411 \times S + 410 \times \overline{S})$ 

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### Features and benefits 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Low-power dissipation
- Non-inverting data path
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

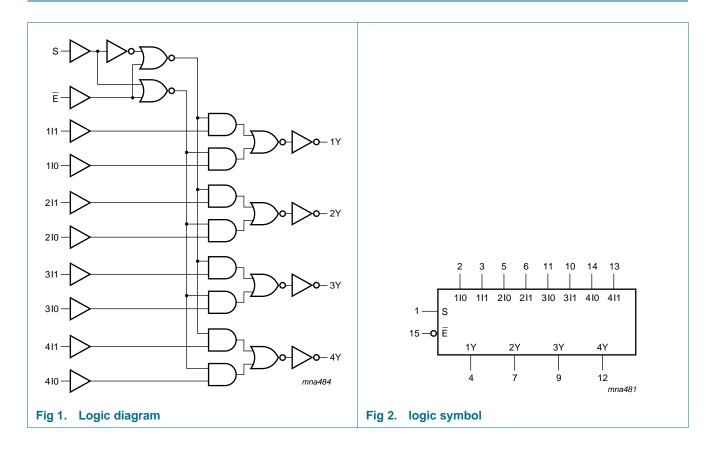


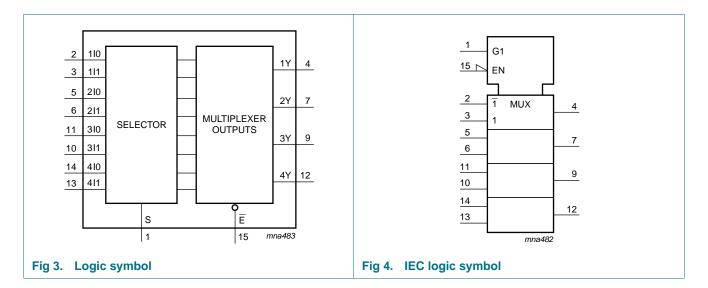
### 3. Ordering information

Table 1. Ordering information

| Type number     | Package           |          |   |          |  |  |  |  |  |
|-----------------|-------------------|----------|---|----------|--|--|--|--|--|
|                 | Temperature range | Name     | Description   | Version  |  |  |  |  |  |
| 74HC157D-Q100   | –40 °C to +125 °C | SO16     | plastic small outline package; 16 leads; body width                                       | SOT109-1 |  |  |  |  |  |
| 74HCT157D-Q100  |                   |          | 3.9 mm  |          |  |  |  |  |  |
| 74HC157PW-Q100  | –40 °C to +125 °C | TSSOP16  | plastic thin shrink small outline package; 16 leads;                                      | SOT403-1 |  |  |  |  |  |
| 74HCT157PW-Q100 |                   |          | body width 4.4 mm   |          |  |  |  |  |  |
| 74HC157BQ-Q100  | –40 °C to +125 °C | DHVQFN16 | plastic dual in-line compatible thermal enhanced  | SOT763-1 |  |  |  |  |  |
| 74HCT157BQ-Q100 | _                 |          | very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm |          |  |  |  |  |  |

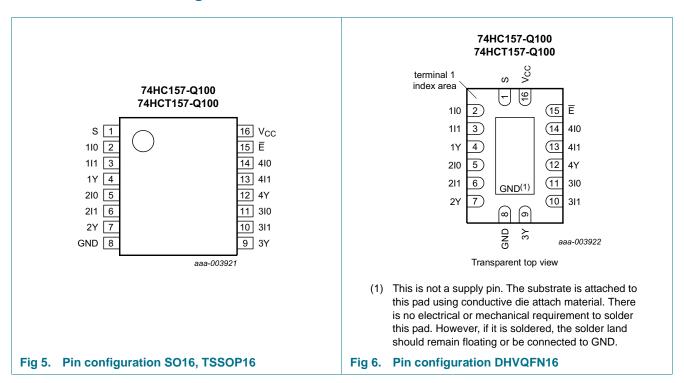
### 4. Functional diagram





### 5. Pinning information

#### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin description

| Symbol     | Pin          | Description               |
|------------|--------------|---------------------------|
| S          | 1            | common data select input  |
| 110 to 410 | 2, 5, 11, 14 | data inputs from source 0 |
| 1I1 to 4I1 | 3, 6, 10, 13 | data inputs from source 1 |
| 1Y to 4Y   | 4, 7, 9, 12  | multiplexer outputs       |
| GND        | 8            | ground (0 V)              |
| Ē          | 15           | enable input (active LOW) |
| $V_{CC}$   | 16           | supply voltage            |

### 6. Functional description

Table 3. Function table[1]

| Input |   |     |     | Output |
|-------|---|-----|-----|--------|
| E     | S | nI0 | nl1 | nY     |
| Н     | X | X   | X   | L      |
| L     | L | L   | X   | L      |
| L     | L | Н   | X   | Н      |
| L     | Н | Χ   | L   | L      |
| L     | Н | X   | Н   | Н      |

<sup>[1]</sup> H = HIGH voltage level;

### 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min          | Max  | Unit |
|------------------|-------------------------|--|--------------|------|------|
| $V_{CC}$         | supply voltage          |  | -0.5         | +7   | V    |
| I <sub>IK</sub>  | input clamping current  | $V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$              | -            | ±20  | mA   |
| I <sub>OK</sub>  | output clamping current | $V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$              | -            | ±20  | mA   |
| I <sub>O</sub>   | output current          | $V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$                | -            | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |  | -            | +50  | mA   |
| $I_{GND}$        | ground current          |  | -            | -50  | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65          | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$ |              |      |      |
|                  | SO16 package            |  | <u>[1]</u> - | 500  | mW   |
|                  | TSSOP16 package         |  | [2] -        | 500  | mW   |
|                  | DHVQFN16 package        |  | [3] _        | 500  | mW   |

<sup>[1]</sup> Ptot derates linearly with 8 mW/K above 70 °C.

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L = LOW voltage level;

X = don't care.

<sup>[2]</sup>  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

[3]  $P_{tot}$  derates linearly with 4.5 mW/K above 60 °C.

### 8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol           | Parameter                           | Conditions               | 74HC1 | 57-Q100 |          | 74HCT | 157-Q10 | 0        | Unit |
|------------------|-------------------------------------|--------------------------|-------|---------|----------|-------|---------|----------|------|
|                  |                                     |                          | Min   | Тур     | Max      | Min   | Тур     | Max      |      |
| $V_{CC}$         | supply voltage                      |                          | 2.0   | 5.0     | 6.0      | 4.5   | 5.0     | 5.5      | V    |
| $V_{I}$          | input voltage                       |                          | 0     | -       | $V_{CC}$ | 0     | -       | $V_{CC}$ | V    |
| Vo               | output voltage                      |                          | 0     | -       | $V_{CC}$ | 0     | -       | $V_{CC}$ | V    |
| T <sub>amb</sub> | ambient temperature                 |                          | -40   | +25     | +125     | -40   | +25     | +125     | °C   |
| Δt/ΔV            | input transition rise and fall rate | $V_{CC} = 2.0 \text{ V}$ | -     | -       | 625      | -     | -       | -        | ns/V |
|                  |                                     | $V_{CC} = 4.5 \text{ V}$ | -     | 1.67    | 139      | -     | 1.67    | 139      | ns/V |
|                  |                                     | $V_{CC} = 6.0 \text{ V}$ | -     | -       | 83       | -     | -       | -        | ns/V |

### 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol Parameter           |                          | Conditions   | T <sub>amb</sub> = 25 °C |      |      | T <sub>amb</sub> = -40 °C to<br>+85 °C |      | T <sub>amb</sub> = -40 °C to<br>+125 °C |      | Unit |
|----------------------------|--------------------------|--|--------------------------|------|------|--|------|---|------|------|
|                            |                          |  | Min                      | Тур  | Max  | Min                                    | Max  | Min                                     | Max  |      |
| 74HC157                    | 7-Q100                   |  | •                        | '    |      |  |      | •                                       | '    | '    |
| $V_{IH}$                   | HIGH-level               | V <sub>CC</sub> = 2.0 V                            | 1.5                      | 1.2  | -    | 1.5                                    | -    | 1.5                                     | -    | V    |
|                            | input voltage            | V <sub>CC</sub> = 4.5 V                            | 3.15                     | 2.4  | -    | 3.15                                   | -    | 3.15                                    | -    | V    |
|                            |                          | $V_{CC} = 6.0 \text{ V}$                           | 4.2                      | 3.2  | -    | 4.2                                    | -    | 4.2                                     | -    | V    |
| $V_{IL}$                   | LOW-level                | V <sub>CC</sub> = 2.0 V                            | -                        | 0.8  | 0.5  | -                                      | 0.5  | -                                       | 0.5  | V    |
|                            | input voltage            | V <sub>CC</sub> = 4.5 V                            | -                        | 2.1  | 1.35 | -                                      | 1.35 | -                                       | 1.35 | V    |
|                            |                          | $V_{CC} = 6.0 \text{ V}$                           | -                        | 2.8  | 1.8  | -                                      | 1.8  | -                                       | 1.8  | V    |
| V <sub>OH</sub> HIGH-level |                          | $V_I = V_{IH}$ or $V_{IL}$                         |                          |      |      |  |      |   |      |      |
|                            | output voltage           | $I_O = -20 \mu A; V_{CC} = 2.0 V$                  | 1.9                      | 2.0  | -    | 1.9                                    | -    | 1.9                                     | -    | V    |
|                            |                          | $I_O = -20 \mu A; V_{CC} = 4.5 V$                  | 4.4                      | 4.5  | -    | 4.4                                    | -    | 4.4                                     | -    | V    |
|                            |                          | $I_O = -20 \mu A; V_{CC} = 6.0 V$                  | 5.9                      | 6.0  | -    | 5.9                                    | -    | 5.9                                     | -    | V    |
|                            |                          | $I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$  | 3.98                     | 4.32 | -    | 3.84                                   | -    | 3.7                                     | -    | V    |
|                            |                          | $I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$  | 5.48                     | 5.81 | -    | 5.34                                   | -    | 5.2                                     | -    | V    |
| V <sub>OL</sub>            | LOW-level                | $V_I = V_{IH}$ or $V_{IL}$                         |                          |      |      |  |      |   |      |      |
|                            | output voltage           | $I_O = 20 \mu A; V_{CC} = 2.0 V$                   | -                        | 0    | 0.1  | -                                      | 0.1  | -                                       | 0.1  | V    |
|                            |                          | $I_O = 20 \mu A; V_{CC} = 4.5 V$                   | -                        | 0    | 0.1  | -                                      | 0.1  | -                                       | 0.1  | V    |
|                            |                          | $I_O = 20 \mu A; V_{CC} = 6.0 V$                   | -                        | 0    | 0.1  | -                                      | 0.1  | -                                       | 0.1  | V    |
|                            |                          | $I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$     | -                        | 0.15 | 0.26 | -                                      | 0.33 | -                                       | 0.4  | V    |
|                            |                          | $I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$     | -                        | 0.16 | 0.26 | -                                      | 0.33 | -                                       | 0.4  | V    |
| lı                         | input leakage<br>current | $V_I = V_{CC}$ or GND;<br>$V_{CC} = 6.0 \text{ V}$ | -                        | -    | ±0.1 | -                                      | ±1.0 | -                                       | ±1.0 | μА   |

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 Table 6.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions  | Ta   | <sub>mb</sub> = 25 | °C   |      | -40 °C to<br>5 °C |     | -40 °C to<br>25 °C | Uni |
|------------------|---------------------------|---|------|--------------------|------|------|-------------------|-----|--------------------|-----|
|                  |                           |   | Min  | Тур                | Max  | Min  | Max               | Min | Max                |     |
| I <sub>CC</sub>  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$  | -    | -                  | 8.0  | -    | 80                | -   | 160                | μΑ  |
| Cı               | input<br>capacitance      |   | -    | 3.5                | -    |      |                   |     |                    | pF  |
| 74HCT1           | 57-Q100                   |   |      |                    |      |      |                   |     |                    |     |
| V <sub>IH</sub>  | HIGH-level input voltage  | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$  | 2.0  | 1.6                | -    | 2.0  | -                 | 2.0 | -                  | V   |
| $V_{IL}$         | LOW-level input voltage   | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$  | -    | 1.2                | 8.0  | -    | 0.8               | -   | 8.0                | V   |
| $V_{OH}$         | HIGH-level                | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$   |      |                    |      |      |                   |     |                    |     |
| output           | output voltage            | $I_O = -20 \mu A$   | 4.4  | 4.5                | -    | 4.4  | -                 | 4.4 | -                  | V   |
|                  |                           | $I_O = -4 \text{ mA}$   | 3.98 | 4.32               | -    | 3.84 | -                 | 3.7 | -                  | V   |
| 0_               | LOW-level                 | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$   |      |                    |      |      |                   |     |                    |     |
|                  | output voltage            | $I_O = 20 \mu A$  | -    | 0                  | 0.1  | -    | 0.1               | -   | 0.1                | V   |
|                  |                           | $I_O = 4.0 \text{ mA}$  | -    | 0.15               | 0.26 | -    | 0.33              | -   | 0.4                | V   |
| I                | input leakage<br>current  | $V_I = V_{CC}$ or GND;<br>$V_{CC} = 5.5 \text{ V}$  | -    | -                  | ±0.1 | -    | ±1.0              | -   | ±1.0               | μΑ  |
| I <sub>CC</sub>  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$  | -    | -                  | 8.0  | -    | 80                | -   | 160                | μΑ  |
| Δl <sub>CC</sub> | additional supply current | $\begin{aligned} &V_{I} = V_{CC} - 2.1 \text{ V;} \\ &\text{other inputs at } V_{CC} \text{ or GND;} \\ &V_{CC} = 4.5 \text{ V to } 5.5 \text{ V;} \\ &I_{O} = 0 \text{ A} \end{aligned}$ |      |                    |      |      |                   |     |                    |     |
|                  |                           | per input pin; nIn inputs   | -    | 100                | 360  | -    | 450               | -   | 490                | μΑ  |
|                  |                           | per input pin; E input  | -    | 60                 | 216  | -    | 270               | -   | 294                | μΑ  |
|                  |                           | per input pin; S input  | -    | 100                | 360  | -    | 450               | -   | 490                | μΑ  |
| Cı               | input<br>capacitance      |   | -    | 3.5                | -    |      |                   |     |                    | pF  |

### 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 9.

| Symbol          | Parameter                           | Conditions   |     | T <sub>ar</sub> | <sub>mb</sub> = 25 | °C  |     | = –40 °C<br>85 °C | T <sub>amb</sub> = -40 °C<br>to +125 °C |     | Unit |
|-----------------|-------------------------------------|--|-----|-----------------|--------------------|-----|-----|-------------------|---|-----|------|
|                 |                                     |  |     | Min             | Тур                | Max | Min | Max               | Min                                     | Max |      |
| For type        | 74HC157-Q1                          | 00   |     |                 |                    |     |     |                   |   |     |      |
| t <sub>pd</sub> | propagation                         | nI0, nI1 to nY; see Figure 7   | [1] |                 |                    |     |     |                   |   |     |      |
|                 | delay                               | $V_{CC} = 2.0 \text{ V}$   |     | -               | 36                 | 125 | -   | 155               | -                                       | 190 | ns   |
|                 |                                     | $V_{CC} = 4.5 \text{ V}$   |     | -               | 13                 | 25  | -   | 31                | -                                       | 38  | ns   |
|                 |                                     | $V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$                                |     | -               | 11                 | -   | -   | -                 | -                                       | -   | ns   |
|                 |                                     | $V_{CC} = 6.0 \text{ V}$   |     | -               | 10                 | 21  | -   | 26                | -                                       | 32  | ns   |
|                 |                                     | S to nY; see Figure 7  | [1] |                 |                    |     |     |                   |   |     |      |
|                 |                                     | $V_{CC} = 2.0 \text{ V}$   |     | -               | 41                 | 125 | -   | 155               | -                                       | 190 | ns   |
|                 |                                     | $V_{CC} = 4.5 \text{ V}$   |     | -               | 15                 | 25  | -   | 31                | -                                       | 38  | ns   |
|                 |                                     | $V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$                                |     | -               | 12                 | -   | -   | -                 | -                                       | -   | ns   |
|                 |                                     | $V_{CC} = 6.0 \text{ V}$   |     | -               | 12                 | 21  | -   | 26                | -                                       | 32  | ns   |
|                 |                                     | E to nY; see Figure 8  | [1] |                 |                    |     |     |                   |   |     |      |
|                 |                                     | $V_{CC} = 2.0 \text{ V}$   |     | -               | 39                 | 115 | -   | 145               | -                                       | 175 | ns   |
|                 |                                     | $V_{CC} = 4.5 \text{ V}$   |     | -               | 14                 | 23  | -   | 29                | -                                       | 35  | ns   |
|                 |                                     | $V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$                                |     | -               | 11                 | -   | -   | -                 | -                                       | -   | ns   |
|                 |                                     | $V_{CC} = 6.0 \text{ V}$   |     | -               | 11                 | 20  | -   | 25                | -                                       | 30  | ns   |
| t <sub>t</sub>  | transition                          | nY; see Figure 7   | [2] |                 |                    |     |     |                   |   |     |      |
|                 | time                                | $V_{CC} = 2.0 \text{ V}$   |     | -               | 19                 | 75  | -   | 95                | -                                       | 110 | ns   |
|                 |                                     | $V_{CC} = 4.5 \text{ V}$   |     | -               | 7                  | 15  | -   | 19                | -                                       | 22  | ns   |
|                 |                                     | $V_{CC} = 6.0 \text{ V}$   |     | -               | 6                  | 13  | -   | 16                | -                                       | 19  | ns   |
| C <sub>PD</sub> | power<br>dissipation<br>capacitance | $C_L = 50 \text{ pF}; f = 1 \text{ MHz};$<br>$V_I = \text{GND to } V_{CC}$ | [3] | -               | 70                 | -   | -   | -                 | -                                       | -   | pF   |
| For type        | 74HCT157-Q                          | 100  |     |                 |                    |     |     |                   |   |     |      |
| t <sub>pd</sub> | propagation                         | nl0, nl1 to nY; see Figure 7   | [1] |                 |                    |     |     |                   |   |     |      |
|                 | delay                               | $V_{CC} = 4.5 V$   |     | -               | 16                 | 27  | -   | 34                | -                                       | 41  | ns   |
|                 |                                     | $V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$                                |     | -               | 13                 | -   | -   | -                 | -                                       | -   | ns   |
|                 |                                     | S to nY; see Figure 7  | [1] |                 |                    |     |     |                   |   |     |      |
|                 |                                     | V <sub>CC</sub> = 4.5 V  |     | -               | 22                 | 37  | -   | 46                | -                                       | 56  | ns   |
|                 |                                     | $V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$                                |     | -               | 19                 | -   | -   | -                 | -                                       | -   | ns   |
|                 |                                     | E to nY; see Figure 8  | [1] |                 |                    |     |     |                   |   |     |      |
|                 |                                     | $V_{CC} = 4.5 \text{ V}$   |     | -               | 15                 | 26  | -   | 33                | -                                       | 39  | ns   |
|                 |                                     | $V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$                                |     | -               | 12                 | -   | -   | -                 | -                                       | -   | ns   |

Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 9.

| Symbol          | Parameter                           | Conditions   |    | T <sub>amb</sub> = 25 °C |     |     | T <sub>amb</sub> = -40 °C<br>to +85 °C |     | T <sub>amb</sub> = -40 °C<br>to +125 °C |     | Unit |
|-----------------|-------------------------------------|--|----|--------------------------|-----|-----|--|-----|---|-----|------|
|                 |                                     |  | Mi | in                       | Тур | Max | Min                                    | Max | Min                                     | Max |      |
| t <sub>t</sub>  | transition                          | nY; see Figure 7 [2]   |    |                          |     |     |  |     |   |     |      |
|                 | time                                | V <sub>CC</sub> = 4.5 V  | -  |                          | 7   | 15  | -                                      | 19  | -                                       | 22  | ns   |
| C <sub>PD</sub> | power<br>dissipation<br>capacitance | $C_L = 50 \text{ pF}; f = 1 \text{ MHz};$<br>$V_I = \text{GND to } V_{CC}$ | -  |                          | 70  | -   | -                                      | -   | -                                       | -   | pF   |

- [1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

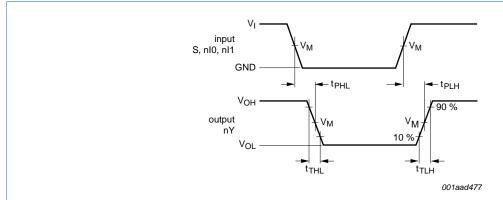
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

### 11. Waveforms



Measurement points are given in Table 8.

 $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

Fig 7. Propagation delay input (nl0, nl1, S) to output (nYn)

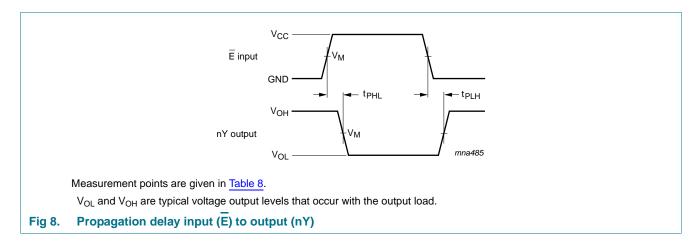
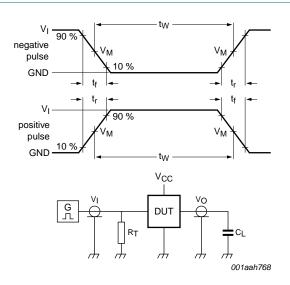


Table 8. Measurement points

| Туре          | Input              | Output             |  |  |
|---------------|--------------------|--------------------|--|--|
|               | V <sub>M</sub>     | V <sub>M</sub>     |  |  |
| 74HC157-Q100  | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> |  |  |
| 74HCT157-Q100 | 1.3 V              | 1.3 V              |  |  |

9 of 17



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance.

S1 = Test selection switch.

Fig 9. Test circuit for measuring switching times

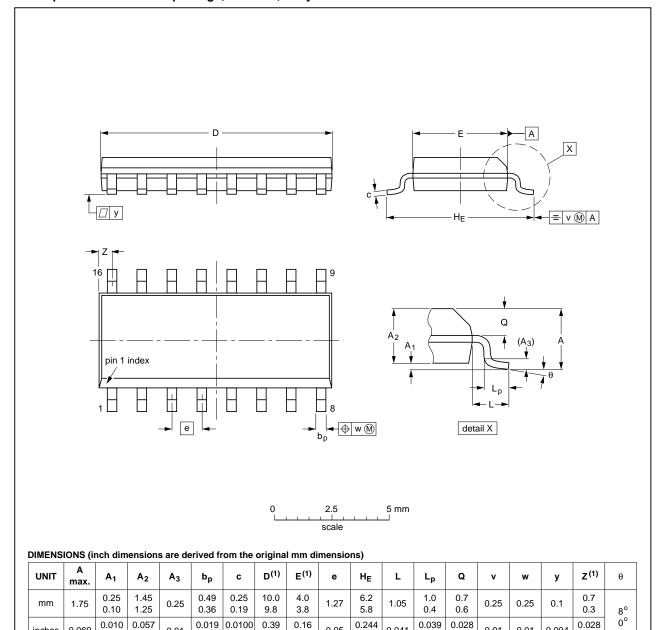
Table 9. Test data

| Туре          | Input           |                                 | Load         | Test                                |
|---------------|-----------------|---------------------------------|--------------|-------------------------------------|
|               | V <sub>I</sub>  | t <sub>r</sub> , t <sub>f</sub> | CL           |                                     |
| 74HC157-Q100  | V <sub>CC</sub> | 6.0 ns                          | 15 pF, 50 pF | t <sub>PLH</sub> , t <sub>PHL</sub> |
| 74HCT157-Q100 | 3.0 V           | 6.0 ns                          | 15 pF, 50 pF | t <sub>PLH</sub> , t <sub>PHL</sub> |

### 12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



inches

0.069

0.004

0.049

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.014 0.0075

0.38

0.15

0.01

| OUTLINE  |        | REFER  | EUROPEAN | ISSUE DATE |            |                                 |  |
|----------|--------|--------|----------|------------|------------|---------------------------------|--|
| VERSION  | IEC    | JEDEC  | JEITA    |            | PROJECTION | ISSUE DATE                      |  |
| SOT109-1 | 076E07 | MS-012 |          |            |            | <del>99-12-27</del><br>03-02-19 |  |

0.05

0.041

0.228

0.01

0.020

0.01

0.004

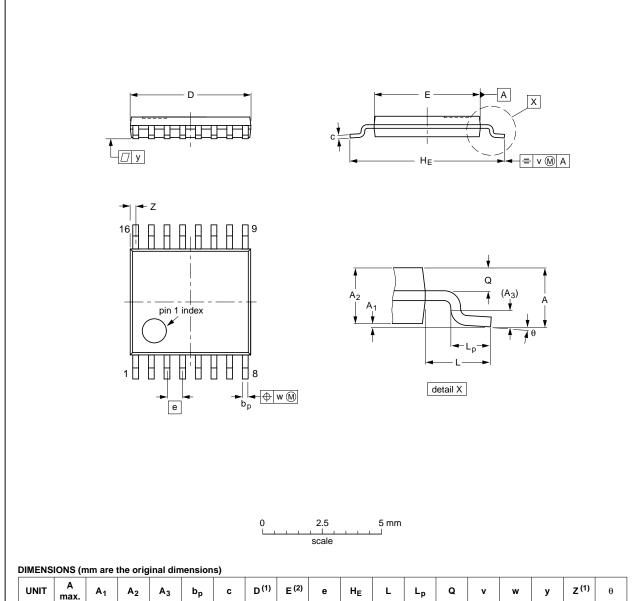
Fig 10. Package outline SOT109-1 (SO16)

74HC\_HCT157\_Q100

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



|      |           |                |                |                |              | -,         |                  |            |      |            |   |              |            |     |      |     |                  |          |
|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С          | D <sup>(1)</sup> | E (2)      | е    | HE         | L | Lp           | Q          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
| mm   | 1.1       | 0.15<br>0.05   | 0.95<br>0.80   | 0.25           | 0.30<br>0.19 | 0.2<br>0.1 | 5.1<br>4.9       | 4.5<br>4.3 | 0.65 | 6.6<br>6.2 | 1 | 0.75<br>0.50 | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.40<br>0.06     | 8°<br>0° |

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE  |     | REFER  | EUROPEAN | ISSUE DATE |            |                                 |  |
|----------|-----|--------|----------|------------|------------|---------------------------------|--|
| VERSION  | IEC | JEDEC  | JEITA    |            | PROJECTION | ISSUE DATE                      |  |
| SOT403-1 |     | MO-153 |          |            |            | <del>99-12-27</del><br>03-02-18 |  |
|          |     |        | •        |            |            |                                 |  |

Fig 11. Package outline SOT403-1 (TSSOP16)

74HC\_HCT157\_Q100

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

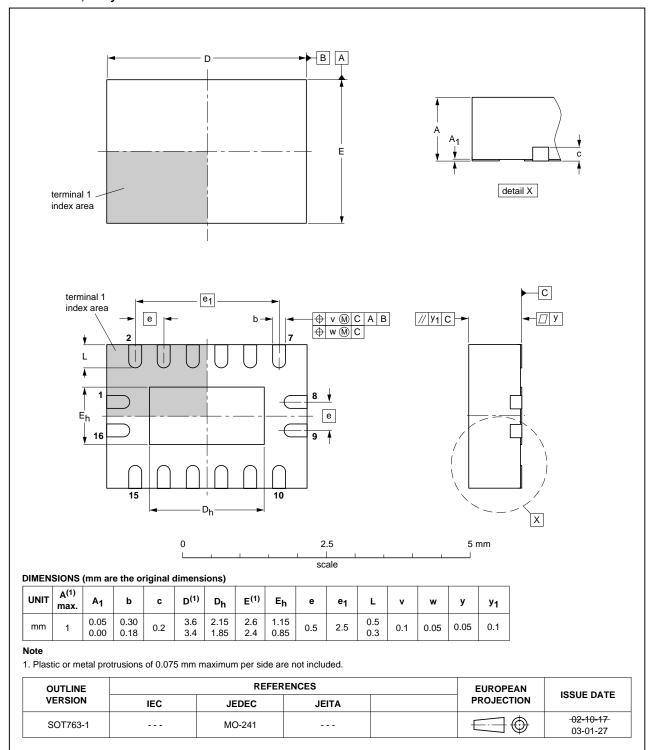


Fig 12. Package outline SOT763-1 (DHVQFN16)

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### 13. Abbreviations

#### Table 10. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| НВМ     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |
| MIL     | Military                                |

### 14. Revision history

#### Table 11. Revision history

| Document ID          | Release date | Data sheet status  | Change notice | Supersedes |
|----------------------|--------------|--------------------|---------------|------------|
| 74HC_HCT157_Q100 v.1 | 20120802     | Product data sheet | -             | -          |

### 15. Legal information

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| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
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| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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## 74HC157-Q100; 74HCT157-Q100

#### **NXP Semiconductors**

**Quad 2-input multiplexer** 

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